

L Number	Hits	Search Text	DB	Time stamp
2	3	dual near3 damacene	USPAT; US-PGPUB	2003/12/14 16:56
3	21	damacene	USPAT; US-PGPUB	2003/12/14 16:56
4	2	damcene	USPAT; US-PGPUB	2003/12/14 16:57
5	6521	damascene	USPAT; US-PGPUB	2003/12/14 16:57
6	3683	dual near5 damascene	USPAT; US-PGPUB	2003/12/14 16:57
7	6534	(dual near3 damacene) damacene damcene damascene (dual near5 damascene)	USPAT; US-PGPUB	2003/12/14 16:57
8	1198	((dual near3 damacene) damacene damcene damascene (dual near5 damascene)) and ((clean\$3 treat\$3 plasma) near20 (insulat\$3 dielelectric IMD ILD))	USPAT; US-PGPUB	2003/12/14 16:58
9	504	((dual near3 damacene) damacene damcene damascene (dual near5 damascene)) and ((clean\$3 treat\$3 plasma) near20 (insulat\$3 dielelectric IMD ILD))) and wet	USPAT; US-PGPUB	2003/12/14 16:59
11	742	((dual near3 damacene) damacene damcene damascene (dual near5 damascene)) and ((clean\$3 treat\$3 plasma) near20 (insulat\$3 dielelectric IMD ILD))) and (wet HF (hydrogen near3 fluoride) (hydro?fluoric near3 acid) (citric near5 acid) (organic near3 acid) solvent (sulfuric near3 acid) (H2SO4) ("H.sub.2" adj2 "S" adj2 "O.sub.4"))	USPAT; US-PGPUB	2003/12/14 17:23
12	3735	(wash\$3 clean\$3 treat\$3) near5 (dielectric inuslat\$3 ILD IMD)	USPAT; US-PGPUB	2003/12/14 17:22
13	6793	(wash\$3 clean\$3 treat\$3) near20 (dielectric inuslat\$3 ILD IMD)	USPAT; US-PGPUB	2003/12/14 17:22
14	7235	(wash\$3 clean\$3 treat\$3) near100 (dielectric inuslat\$3 ILD IMD)	USPAT; US-PGPUB	2003/12/14 17:22
15	7239	(wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)	USPAT; US-PGPUB	2003/12/14 20:53
16	3857	((wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)) and (wet HF (hydrogen near3 fluoride) (hydro?fluoric near3 acid) (citric near5 acid) (organic near3 acid) solvent (sulfuric near3 acid) (H2SO4) ("H.sub.2" adj2 "S" adj2 "O.sub.4"))	USPAT; US-PGPUB	2003/12/14 20:53
17	2061	((wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)) and (wet HF (hydrogen near3 fluoride) (hydro?fluoric near3 acid) (citric near5 acid) (organic near3 acid) solvent (sulfuric near3 acid) (H2SO4) ("H.sub.2" adj2 "S" adj2 "O.sub.4"))) and (hydrogen "H.sub.2")	USPAT; US-PGPUB	2003/12/14 20:53
19	4554	(wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)	EPO; JPO; DERWENT; IBM_TDB	2003/12/14 20:53
20	567	((wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)) and (wet HF (hydrogen near3 fluoride) (hydro?fluoric near3 acid) (citric near5 acid) (organic near3 acid) solvent (sulfuric near3 acid) (H2SO4) ("H.sub.2" adj2 "S" adj2 "O.sub.4"))	EPO; JPO; DERWENT; IBM_TDB	2003/12/14 20:53
21	56	((wash\$3 clean\$3 treat\$3) near1000 (dielectric inuslat\$3 ILD IMD)) and (wet HF (hydrogen near3 fluoride) (hydro?fluoric near3 acid) (citric near5 acid) (organic near3 acid) solvent (sulfuric near3 acid) (H2SO4) ("H.sub.2" adj2 "S" adj2 "O.sub.4"))) and (hydrogen "H.sub.2")	EPO; JPO; DERWENT; IBM_TDB	2003/12/14 20:54
-	385324	dielectric insula\$3	USPAT; US-PGPUB	2003/12/14 16:54
-	60902	(dielectric insula\$3) and plasma	USPAT; US-PGPUB	2003/11/19 18:15
-	23961	((dielectric insula\$3) and plasma) and (hydrogen H2 "H.sub.2")	USPAT; US-PGPUB	2003/11/19 18:15

-	8588	((((dielectric insulat\$3) and plasma) and (hydrogen H2 "H.sub.2")) and wet	USPAT; US-PGPUB	2003/11/19 18:16
-	152	((((dielectric insulat\$3) and plasma) and (hydrogen H2 "H.sub.2")) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 wet)	USPAT; US-PGPUB	2003/11/19 18:17
-	586659	dielectric insulat\$3	USPAT; US-PGPUB	2003/11/25 17:55
-	103006	(dielectric insulat\$3) and (hydrogen H2 "H.sub.2")	USPAT; US-PGPUB	2003/11/25 17:11
-	5325	((dielectric insulat\$3) and (hydrogen H2 "H.sub.2")) and (wet near10 (treat\$3 solution))	USPAT; US-PGPUB	2003/11/25 17:11
-	95	((((dielectric insulat\$3) and (hydrogen H2 "H.sub.2")) and (wet near10 (treat\$3 solution))) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 (wet near10 (treat\$3 solution)))	USPAT; US-PGPUB	2003/11/25 17:52
-	95	((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 (wet near10 (treat\$3 solution)))	USPAT; US-PGPUB	2003/11/25 17:59
-	95	((((dielectric insulat\$3) and (hydrogen H2 "H.sub.2")) and (wet near10 (treat\$3 solution))) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 (wet near10 (treat\$3 solution)))) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 (wet near10 (treat\$3 solution))))	USPAT; US-PGPUB	2003/11/25 17:53
-	10	((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2") near100 (wet near10 (treat\$3 solution)))	EPO; JPO; DERWENT; IBM_TDB	2003/11/25 17:55
-	3568	hydrogen near5 plasma	EPO; JPO; DERWENT; IBM_TDB	2003/11/25 17:59
-	1017779	dielectric insulat\$3	EPO; JPO; DERWENT; IBM_TDB	2003/11/25 17:55
-	660	(hydrogen near5 plasma) and (dielectric insulat\$3)	EPO; JPO; DERWENT; IBM_TDB	2003/11/25 17:55
-	11	((hydrogen near5 plasma) and (dielectric insulat\$3)) and wet	EPO; JPO; DERWENT; IBM_TDB	2003/11/25 17:55
-	6388	hydrogen near5 plasma	USPAT; US-PGPUB	2003/11/25 17:59
-	4548	(dielectric insulat\$3) and (hydrogen near5 plasma)	USPAT; US-PGPUB	2003/11/25 17:59
-	1300	((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet	USPAT; US-PGPUB	2003/11/25 17:59
-	477	((((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2"))	USPAT; US-PGPUB	2003/11/25 18:00
-	380	((((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2"))) and (passivat\$5 treat\$6)	USPAT; US-PGPUB	2003/11/25 18:01
-	380	(((((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2"))) and (passivat\$5 treat\$6)) and plasma	USPAT; US-PGPUB	2003/11/25 22:36
-	380	(((((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2"))) and (passivat\$5 treat\$6)) and plasma	USPAT; US-PGPUB	2003/11/25 22:39
-	186	(((((dielectric insulat\$3) and (hydrogen near5 plasma)) and wet) and ((dielectric insulat\$3) near100 (hydrogen H2 "H.sub.2"))) and (passivat\$5 treat\$6)) and plasma) not tft	USPAT; US-PGPUB	2003/11/25 22:40